- 40-50% lower crimp forceDecreases work-related injuries.
- · Increases productivity.
- · Superior mechanical gain.
- · Interchangeable die sets for wide range of applications.
- OAL: 260mm
- · Individual packing: Blister Card

TAIWAN PATENT:118629 **GERMANY PATENT: 29619451.4**



Material	Weight (g) (Frame only without die)	Weight (g)	Individual packing
S45C	638iÓ10g	700iÓ10	Blister Card

	Complete set with die	Replacement die Set	Description & application	Following modelsare available	
(H)	1PK- 3003FD14	1PK-3003D14	AMP RJ-45 eight- position modular plugs/Primary strain relief crimp bar is located further back on die/modular plugs.	RG-58, RG-59/ 62, BNC/TNC Coax connectors	